MSDE



EDITORIAL

View Article Online



Cite this: Mol. Syst. Des. Eng., 2023,

Introduction to molecular assembly of organic electronics

Dean M. DeLongchamp^a and Ying Diao^b

DOI: 10.1039/d2me90036i

rsc.li/molecular-engineering

Organic electronics are an exciting class of materials that feature conducting and semiconducting properties that originate delocalized π electrons hydrocarbons with extensive conjugation. The applications of organic electronic materials have expanded enormously over the past several decades to include "classic" devices such as organic thin film transistors (OTFTs), organic light emitting diodes (OLEDs), organic photovoltaics (OPVs), and emerging devices such as organic electrochemical transistors (OECTs), organic thermoelectrics. and organic photocatalysts. In all of these devices, the application-relevant physical processes such as the transport of holes, electrons, or excitons occur across a threedimensional material composed of many molecules. Transport among or between molecules is required, therefore molecular assembly their ultimate critically defines performance. Organic conductors and semiconductors have several unique traits that make their assembly processes especially sensitive to molecular design. Their extensive conjugation gives rise to relatively rigid molecular conformation, often necessitating the attachment of

In this themed collection, we explore the application of molecular design principles to the assembly of organic electronics materials, through molecular conformation and packing, mesoscale domain size and orientation, and the formation of complex hierarchical structures. Articles in this collection address the fundamentals crystallization, the interplay of those fundamentals in multicomponent systems, the role of molecular design as followed by in situ characterization of assembly process, interactions between assembled structure charge transport, and realization of principles in emerging these applications primarily focused sensing. These themed collection articles collectively illustrate a rich molecular design space and provide clear development vectors for future innovation in organic electronics.

The most fundamental aspect of assembly in organic electronics materials is crystallization; almost every semiconductor is liauid organic crystalline, semicrystalline, crystalline, and crystals the fundamental subunit of hierarchical structures. Thorley and co-authors (DOI: https://doi.org/10.1039/D1ME00158B)

describe how molecular design principles affect the crystal unit cell of fluoroanthradithiophenes (F-ADTs), a storied family of solution-processable semiconductors featuring organic extremely high hole mobility. Twodimensional brickwork packing is the key to unlocking the performance of F-ADT synthetic variants, and in this article the authors describe side-chain design rules that achieve this special packing motif. Crystal packing is also explored by Yang and co-authors (DOI: https://doi.org/10.1039/D2ME00010E),

who purposefully induce mesoscale chirality in tetrathiafulvalene crystals, demonstrating that significant new optical activity can be gained by inducing chirality in a normally centrosymmetric system. Despite the distortion of the assembly process, the report no negative consequences for charge transport, and in fact some gains were observed. A correct representation of local structure is critically important for accurate computational simulations of organic

side groups to enhance solubility or broaden processing windows. The rich interplay between co-facial and/or edgeto-face π interactions involving planar conjugated moieties, coupled with the accommodate necessity to conformationally flexible solubilization groups having very different packing densities and crystallographic preferences in the same structure, leads to a staggering diversity of assembly motifs. This diversity is further extended by the continued emergence of novel devices and applications featuring multicomponent organic electronics systems, which often display complex and hierarchical assembly.

^a Materials Science and Engineering Laboratory, Materials Measurement Laboratory, National Institute of Standards and Technology, USA

^b Department of Chemical and Biomolecular Engineering, University of Illinois at Urbana-Champaign, Urbana, Illinois 61801, USA

depicting this semiconductors, and especially structure correctly is challenging for polymeric semiconductors (as it is for all semicrystalline polymers) because of their connectivity-constrained structural evolution and multiple anisotropic interactions. Reisjalali and co-authors (DOI: https://doi.org/10.1039/ D1ME00165E) describe a new hybrid computational approach to address this that combines challenge, coarsegraining with atomistic information to yield a highly performant and accurate rendition of local structure

diketopyrrolopyrrole polymers.

MSDE

Molecular design considerations become even more complex multicomponent systems, which are exploited add often to spatially structured electronic or optical heterogeneity. An intriguing example of multicomponent hierarchical assembly is demonstrated by Palmer and coauthors (DOI: https://doi.org/10.1039/ D1ME00139F), with a molecular light harvesting system based on conjugated polyelectrolyte complexes and a lipid vesicle scaffold. Molecular design rules for increasing the aqueous stability of these light harvesting ternary exciton funnels are proposed, including cues for desirable ordering extent, lipid melting point, and conjugated polymer electrolyte sidechain selection. different type of multicomponent system is investigated by DiTusa and coauthors (DOI: https://doi.org/10.1039/ D1ME00192B), who examine a model thermoelectric system in 2,3,5,6tetrafluoro-7,7,8,8-

(F4TCNQ) tetracyanoquinodimethane poly(3-hexylthiophene) vapor-doped (P3HT). Strong correlations are reported between the conductivity of the F4TCNQ-doped P3HT and doping in crystalline domains, illustrating that molecular design principles must be applied to both polymer and dopant, not separately but together as a system to ensure facile access of the dopant to ordered polymer regions.

powerful perspective Α on assembly and molecular design in organic electronics materials is provided through the lens

situ measurements. Although challenging, these measurements reveal nonequilibrium structures transient phases that occur throughout structural evolution and govern its outcomes, but which can be entirely missed by measuring only the assembly endpoints. Wan and co-authors (DOI:

https://doi.org/10.1039/D1ME00078K) demonstrate the power of these methods insitu X-ray scattering describing measurements the solidification of an asymmetric benzothieno-benzothiophene (BTBT) small molecule organic type semiconductor. liquid Α transient crystal state is observed, with a surprisingly slow transformation over minutes or hours, to the stable by a nucleation crystalline phase process. Molecular design principles related to the asymmetry of the attached solubilization groups explain complex structural evolution. Dynamic variations in crystal packing are also explored by Talnack and coauthors (DOI: https://doi.org/10.1039/ D1ME00153A), who examine polymorphism in dinaphthothienothiophene (DNTT) type small molecule organic semiconductor. This promising high hole mobility material must be processed temperatures near a recently-discovered polymorphic phase transition, and the new crystal unit cell revealed by in situ methods is studied to understand thermal expansion and its implications for device performance. The authors find the DNTT polymorphism to be governed by side chain orientations, delivering molecular design cues for tailoring polymorphism behaviors by side chain engineering. In an unusual computational in situ study, Ryno and co-authors (DOI: https://doi.org/10.1039/ D1ME00157D) demonstrate a combined molecular dynamics and graph characterization approach the to solidification of ADT type organic semiconductors. This novel combination of computational approaches explains differences in the structural evolution of the syn- and anti-isomers of ADT as they solidify from gas, to liquid, to solid. Dramatic

in the differences are observed smoothness of the assembly transitions and in the ultimate long axis ordering and final crystal morphology revealed by graph feature analysis. The results indicate a clear rationale for isomer separation and reinforce the expectation that isomerism matters in this widely used family of organic semiconductors.

Charge transport is a key physical process in almost every organic electronics device. Interrelationships between assembly and charge transport are explored by Pokuri and co-authors https://doi.org/10.1039/ (DOI: D1ME00163A), who exploit all-atom simulations and graph theory characterization approaches to characterize the resilience of charge transport in PTB7, a model holetransport material for OPVs. The authors study resiliency by selectively 'deactivating' monomers, ultimately demonstrating that the assembled PTB7 morphology is surprisingly resilient to the removal of parts of the morphology. The article provides a sophisticated advancement over simple percolation arguments by assessing atomistically realistic morphologies with highly performant modern abstraction algorithms. It suggests a convincing argument that charge transport in some systems may be governed by a minority of the assembled film structure, and it provides a powerful framework for designing resilient systems in silico.

Finally, a pair of minireview articles explore the themes of this collection from the perspective of emerging sensing applications in organic electronics. Interrelationships between assembled structure and chemical sensing are explored by Zhi and co-authors (DOI: https://doi.org/10.1039/D2ME00020B), with themes including morphologydependent signal amplification and the effects of molecular stacking, thickness, grain boundaries, molecular orientation, and mesoscale structure. Molecular design principles are reviewed including the interplay of hydrogen bonding and π -stacking interactions,

structure manipulation by processing,

and

and

heteroatom effects,

Meso-

selection.

side chain

macro-scale

Editorial MSDE

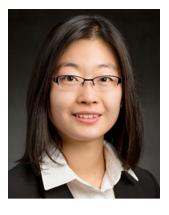
surface engineering, and nanoparticle inclusions are also discussed. A second minireview by Zhu and co-authors (DOI: https://doi.org/10.1039/D1ME00134E) focuses on the polymeric organic electrochemical transistors and their design principles, with valuable coverage of structural characterization methods and computational approaches, followed by discussion of morphology control strategies including the synthetic design of backbones and sidechains and approaches formulation and processing. The engineering of the electrolyte-polymer interface is highlighted as a provocative emerging set of considerations that is quite unique to the organic electrochemical transistor device.

We thank the authors, reviewers, and the editorial staff at Molecular Systems Design & Engineering for contributing to this themed collection. Molecular design in organic electronics continues to evolve at a rapid pace, and this collection illustrates a trajectory of increasing sophistication in the prediction and manipulation of structures for optimization in specific applications. We anticipate an exciting future where molecular design demands driven by the increased complexity of multicomponent and hierarchically structured organic electronics materials, create a virtuous cycle of enhanced molecular design rules, processing rules, structural measurements, and advanced computational approaches that dramatically accelerate progress and expand the breadth of applications in years to come.



Dean M. DeLongchamp is the leader of the Polymer Processing Group in the Materials Science and Engineering Division of the Material Measurement Laboratory of the National Institute of Standards and Technology (NIST). He received his PhD in chemical engineering from the Massachusetts Institute of Technology. His group develops measurement methods, data, standards, and science for the processing and manufacturing of materials functional forms that include thin films, nanostructures, and shaped bulk solids.

scientific portfolio includes His specializations in material structure measurements for organic electronics technologies and in soft X-ray spectroscopy and scattering, which are powerful synchrotron-based tools that measure the composition and molecular orientation of organic systems. He has published over 135 scientific articles, and has received honors including the Presidential Early Career Award for Scientists and Engineers and the Arthur S. Flemming Award to honor outstanding federal employees.



Ying Diao is an associate professor, I. C. Gunsalus Scholar and Dow Chemical Company Faculty Scholar at the University of Illinois at Urbana-Champaign. She received her PhD degree from MIT in 2011, and pursued postdoctoral training at Stanford University from 2011 to 2014. Her research group, started in 2015 at Illinois, focuses on understanding the organic assembly of functional materials innovating printing and that enable structural approaches control down to the molecular and nanoscale. work has been Her frequently featured in scientific journals and news media. She was named in the MIT Technology Review's annual list of Innovators Under 35 as a pioneer in nanotechnology materials. She is also a recipient of the NSF CAREER Award, NASA Early Career Faculty Award, 3M Non-Tenured Faculty Award, and was selected as a Sloan Research Fellow in Chemistry as one of the "very best scientific minds working today".